

Layer Name	Туре	Material	Thickness (mm)	Color	Epsilon R	Loss Tangent
F.Silkscreen	Top Silk Screen	Liquid Photo	0 mm	White	1	0
F.Paste	Top Solder Paste		0 mm		1	0
F.Mask	Top Solder Mask	Liquid Ink	0.01 mm	Green	3.3	0
F.Cu	copper		0.03556 mm		1	0
Dielectric 1	core	R04350B	0.762 mm	FR4 natural	3.66	0.0037
B.Cu	copper		0.03556 mm		1	0
B.Mask	Bottom Solder Mask	Liquid Ink	0.01 mm	Green	3.3	0
B.Paste	Bottom Solder Paste		0 mm		1	0
B.Silkscreen	Bottom Silk Screen	Liquid Photo	0 mm	White	1	0

Notes: LNA footprint	is pin-compa	tible with PMA2-123LN+.		
			Remy Ng	juyen
Sheet: File: 002.35.2	20.15.20-001-	-PCB-LNA.kicad_pcb		
Title: RF-DI	FS Gain Circui	t		
Size: A4	Date: 7/6	5/2023	Rev: A	
KiCad E.D.A.	kicad 7.0.5	ld: 1/1		
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